Notice for TAIYO YUDEN Products

Please read this notice before using the TAIYO YUDEN products.

⚠ REMINDERS

Product Information in this Catalog

Product information in this catalog is as of October 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Reproved or induct specimeations.

Please contact TAMO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAMO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability events on the production and the production device and/or of (ii) systems equipped with a redundant circuit or other system to prevent an unsels status in the event of a single fault for a failsafe deeging to

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor partial any license under such rights.

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement, (e.g., supply and purchase agreement, quality assurance agreement) signed by TAYO YUDEN and your company, TAYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets,

TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinather "TAMO YUDDN's official sales channel"), "Resea note that the contents of this catalog are not applicable to our products purchased from any selfer other than TAMO YUDEN's official sales channel.

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

TAIYO YUDEN 2022

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment inclining, without initiation, mobile phone, and PCI and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN. TAIYO YUDEN has be product series intended for use in the following equipment. Therefore, when using our products for these TAIYO YUDEN has be product series intended for use in the following equipment. Therefore, when using our products for these tenders are the series of the product series intended for use in the following equipment. Therefore, when using our products for these tenders are the corresponding products.

| A B Mari | | | 0 |
|-------------|---|-----------------------------------|------------------|
| Application | Equipment '1 | Category (Part Number Code 12) | Quality Grade '3 |
| Automotive | Automotive Electronic Equipment (POWERTRAIN, SAFETY) | A | 1 |
| Additiotive | Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT) | С | 2 |
| Industrial | Telecommunications Infrastructure and Industrial Equipment | В | 2 |
| Medical | Medical Devices classified as GHTF Class C (Japan Class III) | М | 2 |
| iviedicai | Medical Devices classified as GHTF Classes A or B (Japan Classes I or II) | L | 3 |
| Consumer | General Electronic Equipment | s | 3 |

Notes: 1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAYO YUDEN before using our products for equipment of the than these covered by the product series.

2. On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details, please feet, the explanatory instrinate regarding the part numbering system of each of our products.

3. Each product series a sanginger of water goods from 10 of a red or higher quality. Please is comparate a product into any equipment with a higher builty Grade than the Quality Grade of such product series.

2. Equipment Requiring Inquiry

Flease be sure to contact TAIVO YUDEN for further information before using the products listed in this catalog for the following equipment excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- products and/or malfunction attributed thereto.

 (1) Transportation equipment (automotive powertain control system, train control system, and ship control system, etc.)

 (2) Traffic signal equipment

 (3) Disaster prevention equipment, crime prevention equipment

 (4) Medical devices classified as GHTF Class C (Japan Class III)

 (5) Highly bublic information network equipment, data-processing equipment (felephone exchange, and base station, etc.)

 (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability. (1) Aerospace equipment (artificial satellite, rocket, etc.)

- (1) Aerospace equipment in an invalidation of the control of the c Notes: 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of accraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAYO VIDEN freese be sure to contact TAYO YUDEN for further information before using our products for such
 - aviation equipment.

 Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Medical Application Guide

According to the medical devices classified as GHTF Classes A to C (Japan Classes I to III), we have the corresponding product series (the part number code of 2nd digit from the left side is "M" or "L") intended for use in the medical devices. Therefore, when using our products for the medical devices, please be sure to check the classification based on the GHTF Rules and use the corresponding

please be sure to check the classification based on the contraction and contraction product series.

On the other hand, we don't have the product series intended for use in (i) all medical devices classified as GHTF Class D (Japan Class IV) and (ii) implantable medical devices (bone-anchored hearing aid, artificial retina system, and external unit which is connected to internal unit which is implanted in a body, etc.). Therefore, please do not incorporate our products into these medical devices. Should you have any questions on this matter, please contact us.

| Risk | Level | Low | | | | | High |
|--------|--|---|------------------------------|---|---|-----|--|
| | | Class I General Medical Devices (GHTF Class A) | M | Class II Controlled edical Devices GHTF Class B) | Class III Specially-contr Medical Devi (GHTF Class | ces | Class IV Specially-controlled Medical Devices (GHTF Class D) |
| | g to les) | Medical devices with extremely low risk to the human body in case of problems | | devices with ly low risk to the body in case of ns | Medical devices with relatively high risk to the human body in case of problems | | Medical devices highly invasive to patients and with life-threatening risk in case of problems |
| Japan | of problems Exal In Vitro Diagnosti Devices He building Devices He building Devices He building He building | | [Ex]. | | [Ex.] | | [EX.] *Cardiac Pacemaker *Viceo Flexible *Viceo Flexib |
| | cation | Class I General Controls | | Clar General Co Special | ntrols and | | Class III General Controls and Premarket Approval |
| U.S.A. | FDA Classification | Medical devices witho possibility of causing s injury or harm to the p or user even if there is or malfunction in such medical devices | erious atient a defect | harm to the p there is a defe | cas with the causing injury or potent or user if feet or malfunction dedical devices with the possibility of causing serious injury, disability or death to the patient or user if a defect or malfunction occurs in such medical devices | | |
| | | | | | | 7 | |

Product Series for Medical Devices classified as GHTF Class ((Japan Class III) (Part Number Code of 2nd Digit From the Product Series for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II) (Part Number Code of 2nd Digit from the Left Side: "L") TAIYO YUDEN Product Series

TAIYO YUDEN 2022

for Medical Devices Equipment

Packaging

Multilayer Metal Power Inductors MCOIL™ LLCN series for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

L L C N A 2 0 1 2 H K T 1 R 0 M T 2 3 4 5 6 7

Metal Multilava

Quality Grade

Feature 3Dimensions (L × W

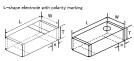
®Internal code

^{*} Note: It is prohibited that our products are used in some medical devices such as implantable medical devices even if such medical

> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please chack our specification. For details of each product (characteristics graph, reliability information, precastions for use, and so only see our Web site (http://www.ty-tep.com/).

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY







Bottom electrode with polarity marking



| uantity[pcs] | Standard q | | т | w | | Type |
|--------------|------------|---------------|-------------|---------------|---------------|--------|
| Embossed tap | Paper tape | е | , | W | L | Type |
| | 10000 | 0.25±0.15 | 0,55 max | 0,5±0,2 | 1.0±0.2 | 1005EE |
| _ | 10000 | (0.010±0.006) | (0,022 max) | (0.020±0.008) | (0.039±0.008) | (0402) |
| | 5000 | 0.30±0.2 | 0,50 max | 1.05±0.1 | 1.25±0.1 | 1210EK |
| _ | 5000 | (0.012±0.008) | (0.020 max) | (0.041±0.004) | (0.049±0.004) | (0504) |
| | 4000 | 0.50±0.2 | 0,65 max | 1.2±0.2 | 1.4±0.2 | 1412FE |
| _ | 4000 | (0.02±0.008) | (0,026 max) | (0.047±0.008) | (0.055±0.008) | (0505) |
| | 4000 | 0.3±0.2 | 0.60 max | 0.8±0.2 | 1.6±0.2 | 1608FK |
| _ | 4000 | (0.012±0.008) | (0,024 max) | (0.031±0.008) | (0.063±0.008) | (0603) |
| _ | 4000 | 0.3±0.2 | 0,65 max | 0.8±0.2 | 1.6±0.2 | 1608FE |
| _ | 4000 | (0.012±0.008) | (0.026 max) | (0.031±0.008) | (0.063±0.008) | (0603) |
| _ | 4000 | 0.4±0.2 | 0.80 max | 0.8±0.2 | 1.6±0.2 | 1608HK |
| _ | 4000 | (0.016±0.008) | (0.031 max) | (0.031±0.008) | (0.063±0.008) | (0603) |
| 3000 | | 0.3±0.2 | 1,0 max | 0.8±0.2 | 1.6±0.2 | 1608KK |
| 3000 | | (0.012±0.008) | (0,039 max) | (0.031±0.008) | (0.063±0.008) | (0603) |
| _ | 4000 | 0.5±0.3 | 0,80 max | 1.25±0.2 | 2.0±0.2 | 2012HK |
| _ | 4000 | (0.02±0.012) | (0,031 max) | (0.049±0.008) | (0.079±0.008) | (0805) |
| 3000 | | 0.5±0.3 | 1.0 max | 1.25±0.2 | 2.0±0.2 | 2012KK |
| 3000 | | (0.02±0.012) | (0.039 max) | (0.049±0.008) | (0.079±0.008) | (0805) |
| | 4000 | 0.5±0.3 | 0.65 max | 1.6±0.2 | 2.0±0.2 | 2016FE |
| _ | 4000 | (0.02±0.012) | (0,026 max) | (0.063±0.008) | (0.079±0.008) | (0806) |

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 For details of each product (characteristics graph, reliablely information, precautions for use, and so onl, see our Web site (http://www.ty=tep.com/).

CATALOG 2022

TAIYO YUDEN

i_mlci_MC_L_e=E10R01

or Medical Devices Equipment

| | PAR' | N | ж | вε | Į |
|---|------|------|---|----|---|
| | | | | | |
| 0 | 1006 | turn | | | |

| reference) EHS | Nominal industance | Inductance tolerance | | sistanos Ω] | Rated current(Ide1) | Rated current(lde2) | Measuring frequency | Thickness [mm] (max.) |
|----------------|--|--|--|--|------------------------|------------------------|--|---|
| returnity) | (410) | | (max.) | (typ.) | [A] (max.) | [A](max.) | [MHz] | (min) (mix) |
| OSTRIOMHN RoH | 0.10 | ±20% | 50 | 41 | 2.0 | 2.0 | - | 0.55 |
| 05TR22MHN RoH | 0.22 | ±20% | 80 | 65 | 1.6 | 1.6 | - 1 | 0.55 |
| 05TR47MHN RoH | 0,47 | ±20% | 140 | 114 | 1.2 | 1,2 | 1 | 0.55 |
| 05T1R0MHN RoH | 1.0 | ±20% | 300 | 244 | 1.0 | 0.8 | 1 | 0.55 |
| | 05TR10MHN RoHS 05TR22MHN RoHS 05TR47MHN RoHS | (p H) (p H) (0 TR10MHN RoHS 0.10 (0 TR22MHN RoHS 0.22 (0 TR47MHN RoHS 0.47 (47 1 TR47MHN ROHS 0. | (2 H) (2 H | (max.) (| (AH) (Max.) (tyx.) | Celemental 1,211 | references (JPH) (msz.) (ygg.) (Al(msz.) (Al(msz.) (DYR)) (2007R1006M) RoseS (10 ±2016 50 41 2.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0 1 | references LPH1 (max.) (typ.) (A) (max.) (A) (max.) (Mex) OST TOZAMNI Revist 0.0 ±20% 50 41 2.0 2.0 1 OST TOZAMNI Revist 0.22 ±20% 80 65 1.8 1.8 1 OST TOZAMNI Revist 0.47 ±20% 10 65 1.8 1.2 1.2 |

| Old part number BHS | | Nominal inductance | Inductance tolerance | DC Resistance [mΩ] | | Rated current((dc1) | Rated Measuring current(Ido2) frequency | | Thickness (mm) (max) |
|---------------------|--|--|--|---|----------------------|--|--|--|-------------------------|
| OCA TOTAL BILLION | | Ljena | | (max.) | (typ.) | [A] (max.) | [A] (mas.) | [MHz] | (mind (max) |
| K1210TR47MHN | RoHS | 0.47 | ±20% | 82 | 70 | 2.3 | 1.6 | - 1 | 0.50 |
| K1210T1R0MHN | RoHS | 1.0 | ±20% | 179 | 157 | 1.5 | 1.1 | _ | 0.50 |
| K1210T1R5MHN | RoHS | 1.5 | ±20% | 240 | 200 | 1.2 | 0.9 | _ | 0.50 |
| e K | for reference) (1210TR47MHN (1210T1R0MHN | for reference) EHS (1210TR47MHN RoHS (1210T1R0MHN RoHS | for reference) BHS [M H] (1210TR47MHN RoHS 0.47 (1210T1R0MHN RoHS 1.0 | for reference) EHS [µ H] Inductance tolerance (1210TR47MHN RoHS 0.47 ±20% (1210TR9MHN RoHS 1.0 ±20% | Id part number EHS | dg swit marker EHS Nomissal Industance Industrance Industrance | Montreel Industriant Montreel Industriant | Section Sect | |

●1412 type

| New part number | Old part number (for reference) | EHS | Nominal inductance | Industance tolerance | | sistance Ω] | Rated current((dc1) | Rated current(ldc2) | Measuring frequency | Thickness [mm] (max) |
|-------------------|------------------------------------|------|--------------------|----------------------|--------|----------------|------------------------|------------------------|------------------------|-------------------------|
| | OW TOTAL GIVE | | Lieni | | (max.) | (typ.) | [A] (max.) | [A] (max.) | [MHz] | (mini onace) |
| LLCND1412FETR33MC | MCFE1412TR33MJB | RoHS | 0.33 | ±20% | 32 | 29 | 5.0 | 3.7 | - 1 | 0.65 |
| LLCND1412FETR47MC | MCFE1412TR47MJB | RoHS | 0.47 | ±20% | 42 | 39 | 3.0 | 3.1 | - 1 | 0.65 |

| 1608 type | | | | | | | | | | |
|-------------------------------|--|---|--|--|-----------------|------------------|------------------------|--|--|--------------------------|
| New part number | Old part number | EHS | Nominal inductance | Inductance tolerance | | | Rated current((dc1) | Rated current(ldic2) | Measuring frequency | Thickness [mm] (max.) |
| | , at 1414 and 5 | | 1910 | | (max.) | (typ.) | [A](max.) | [A](max.) | [MHz] | |
| LLCNA1603FKTR24MA | MCFK1606TR24M | RoHS | 0.24 | ±20% | 50 | 40 | 2.3 | 2.1 | 1 | 0.60 |
| LLCNA1603FKTR47MA | MCFK1808TR47M | RoHS | 0,47 | ±20% | 85 | 69 | 1,9 | 1,6 | - 1 | 0.60 |
| LLCNA1608FKT1R0MA | MCFK1608T1R0M | RoHS | 1.0 | ±20% | 224 | 182 | 1.5 | 0.9 | - 1 | 0.00 |
| LLCNE1608FETR24MA | MCFE1608TR24MG | RoHS | 0.24 | ±20% | 100 | 75 | 2.6 | 1.5 | - 1 | 0.65 |
| LLCNE1808FETR47MA | MCFE1608TR47MG | RoHS | 0.47 | ±20% | 150 | 114 | 2.0 | 1.2 | - 1 | 0.65 |
| LLCNE1608FET1R0MA | MCFE1608T1R0MG | RoHS | 1.0 | ±20% | 340 | 270 | 1.4 | 0.8 | - 1 | 0.65 |
| LLCNB1808HKTR24MD | MCHK1608TR24MKN | RoHS | 0.24 | ±20% | 24 | 20 | 4.3 | 3.7 | 1 | 0.80 |
| LLCNB1608HKTR47MD | MCHK1608TR47MKN | RoHS | 0.47 | ±20% | 43 | 38 | 3.3 | 2.7 | - 1 | 0.80 |
| LLCNB1808HKTR58MD | MCHK1688TR56MKN | RoHS | 0.56 | ±20% | 55 | 45 | 2.7 | 2.6 | 1 | 0.80 |
| LLCNB1608HKT1R0MD | MCHK1608T1ROMKN | RoHS | 1,0 | ±20% | 110 | 89 | 2.2 | 1.6 | - 1 | 0.80 |
| LLCNB1808HKT1R5MD | MCHK1608T1R5MKN | RoHS | 1.5 | ±20% | 200 | 160 | 1.7 | 1.3 | - 1 | 0.80 |
| LLONB1808HKT2R2MD | MCHK1608T2R2MKN | RoHS | 2.2 | ±20% | 292 | 237 | 1.5 | 1.2 | 1 | 0.80 |
| LLCNB1608KKTR24MA | MCKK1608TR24M N | RoHS | 0.24 | ±20% | 38 | 35 | 2.8 | 2.6 | - 1 | 1.00 |
| LLONB1808KKTR47MA | MCKK1608TR47M N | RoHS | 0,47 | ±20% | 55 | 44 | 2.4 | 2.0 | 1 | 1,00 |
| LLCNB1608KKT1R0MA | MCKK1608T1R0M N | RoHS | 1.0 | ±20% | 123 | 100 | 2.0 | 1.3 | - 1 | 1.00 |
| | New part number LLCNA 1608FKTR24MA LLCNA 1608FKTR24MA LLCNA 1608FKTR24MA LLCNA 1608FKT 160MA LLCNA 1608FKT 160MA LLCNA 1608FKTR24MA | Nos part nortice The part nortice The reference of the | Non-part number Glayers number GP11 LICHANGESPITTEMEN NOT INSTITUTE PROPERTY OF THE PARTY NOT INSTITUTE PROPERTY OF THE PARTY NOT INSTITUTE PROPERTY OF THE PARTY NOT INSTITUTE PROPERTY NOT INSTITUTE PROPER | Non-part number College or maker Early Early | Non-part number | Non-part nonitor | Non-part nonine | Non-part-number Disperant member Disperant me | Non-part-number Descriptions D | Res part notice |

02016 type

| Ì | New part number | Old part number (for reference) | EHS | Nominal inductance | Inductance telerance | | istanoe Ω] | Rated current((dc1) | Rated current(ldc2) | Measuring frequency | Thickness [mm] [max.) |
|---|--------------------|------------------------------------|------|--------------------|----------------------|--------|---------------|------------------------|------------------------|------------------------|-----------------------|
| | | | | | | (max.) | (typ.) | [A](max.) | [A] (mas.) | [MHz] | |
| | LLCNE2018FETR47MCB | MCFE2016TR47MJG B | RoHS | 0.47 | ±20% | 45 | 40 | 4.0 | 3.2 | 1 | 0.65 |
| 1 | LLCNE2016FETR88MCB | MCFE2016TR68MJG B | RoHS | 0.68 | ±20% | 60 | 50 | 3.0 | 2.5 | - 1 | 0.65 |
| ı | LLCNE2016FET1R0MC8 | MCFE2016T1R0MJG B | RoHS | 1.0 | ±20% | 70 | 60 | 2.8 | 2.3 | - 1 | 0.65 |

#88c1 is the DC value at which the initial L value is decreased within 30% by the application of DC bias. (at 20°C) #86c2 is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

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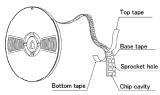
Multilayer Metal Power Inductors MCOIL™ LSCN/LCCN/LBCN/LLCN/LMCN series

■PACKAGING

| Type | | Thickness | Standard Q | uantity [pcs] |
|-------------|------|----------------------|------------|---------------|
| Type | Code | mm (inch) | Paper Tape | Embossed Tape |
| 1005 (0402) | EE | 0.55 max (0.022 max) | 10000 | - |
| 1210 (0504) | EK | 0.5 max (0.020 max) | 5000 | - |
| 1412 (0505) | FE | 0.65 max (0.026 max) | 4000 | - |
| 1608 (0603) | FK | 0.6 max (0.024 max) | 4000 | - |
| 1608 (0603) | FE | 0.65 max (0.026 max) | 4000 | - |
| 1608 (0603) | HK | 0.8 max (0.031 max) | 4000 | - |
| 1608 (0603) | KK | 1.0 max (0.039 max) | - | 3000 |
| 2012 (0806) | HK | 0.8 max (0.031 max) | 4000 | - |
| 2012 (0805) | KK | 1.0 max (0.039 max) | - | 3000 |
| 2016 (0206) | CC | 0.65 may (0.026 may) | 4000 | |

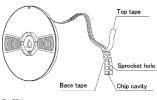
©Taping material

Card board carrier tape 1005/1210/1412/1608/2012/2016 type





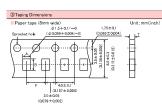




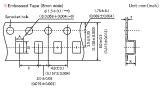


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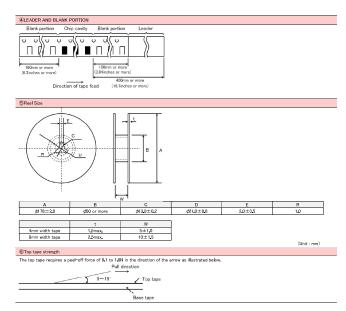
TAIYO YUDEN



| Type 1005 (0402) 1210 (0504) | EE EK | mm (inch) 0.55 max (0.021 max) 0.5 max (0.020 max) | A 0.8 (0.031) 1.3 | B 1.3 (0,051) | F 2.0±0.05 (0.079±0.002) | T 0.64max (0.025max) |
|------------------------------------|----------|--|----------------------------|---------------------|--------------------------------|----------------------------|
| | | (0.021 max) 0.5 max | (0,031) | (0.051) | | |
| 1210 (0504) | EK | | 1.3 | | | |
| | | | (0.051) | 1.55 (0.061) | 4.0±0.1 (0.157±0.004) | 0.64max (0.025max) |
| 1412 (0505) | FE | 0.65 max (0.026 max) | 1.6 (0.063) | 1.8 (0.071) | 4.0±0.1 (0.157±0.004) | 0.72max (0.028max) |
| 1608 (0603) | FK | 0.6 max (0.024 max) | 1.1 (0.043) | 1.9 (0.075) | 4.0±0.1 (0.157±0.004) | 0.72max (0.028max) |
| 1608 (0603) | FE | 0.65 max (0.026 max) | 1.1 (0.043) | 1.9 (0.075) | 4.0±0.1 (0.157±0.004) | 0.72max (0.028max) |
| 1608 (0603) | HK | 0.8 max (0.031 max) | 1.2 (0.047) | 2.0 (0.079) | 4.0±0.1 (0.157±0.004) | 0.9max (0.035max) |
| 2012 (0805) | HK | 0.8 max (0.031 max) | 1.65 (0.065) | 2.4 (0.094) | 4.0±0.1 (0.157±0.004) | 0.9max (0.035max) |
| 2016 (0806) | FE | 0.65 max (0.026 max) | 1.95 (0.077) | 2.3 (0.091) | 4.0±0.1 (0.157±0.004) | 0.72max (0.028max) |



| Type | | Thickness | Chip | cavity | Insertion Pitch | Tape Th | ickness |
|-------------|------|-------------|---------|---------|-----------------|-------------|-------------|
| Type | Code | mm (inch) | A | В | F | К | T |
| 1608 (0603) | KK | 1.0 max | 1,1 | 1,95 | 4.0±0.1 | 1.5 max | 0.3 max |
| 1000 (0003) | NA. | (0,039 max) | (0.043) | (0.077) | (0.157±0.004) | (0,059 max) | (0.012 max) |
| 2012 (0805) | KK | 1.0 max | 1.55 | 2,35 | 4.0±0.1 | 1.45 max | 0.3 max |
| 2012 (0805) | NA. | (0.039 max) | (0.061) | (0.093) | (0.157±0.004) | (0.057 max) | (0.012 max) |
| | | | | | | Unit : mr | n (inch) |



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Multilayer Metal Power Inductors MCOIL™ LSCN series for General Electronic Equipment for Consumer

Multilayer Metal Power Inductors MCOIL™ LLCN series

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

| | 10 |
|-----------------------------|---|
| 1. Operating Tempe | erature Range |
| Specified Value | -40~+125°C (Including self-generated heat) |
| ., | the contracting and generalized the contractions |
| 2. Storage Tempera | ture Range |
| Specified Value | −40~ +85°C |
| | |
| 3. Rated Current | |
| Specified Value | Ido1: The decreasing-rate of inductance value is within 30 % |
| Opecined value | Ido2: The temperature of the element is increased within 40°C |
| | |
| 4. Impedance | |
| Specified Value | - |
| | |
| 5 Inductance | |
| Specified Value | Refer to each specification. |
| Test Methods and Remarks | Measuring frequency : 1MHz Measuring equipment : E4991(or its equivalent) |
| rvem8FK8 | measuring equipment . C4931/OFRS equivalent/ |
| 6. Q | |
| Specified Value | I = |
| oposition raido | |
| 7. DC Resistance | |
| Specified Value | Refer to each specification, |
| Test Methods and | |
| Remarks | Measuring equipment: H[OKI RM3545 (or its equivalent) |
| | |
| 8. Self Resonance F | requency (SRF) |
| | - |
| | |
| 9. Resistance to Fle | |
| Specified Value | No mechanical damage. |
| | Warp : 2mm |
| | Testing board : glass epoxy-resin substrate |
| | Thickness : Q.8mm |
| | |
| | |
| Test Methods and | R-230 Warp |
| Remarks | Nath Nath |
| | |
| | A Briston + 1A |
| | 45 45 |
| | (Unit:mm) |
| | |
| | |
| 10. Solderability | |
| Specified Value | At least 90% of terminal electrode is covered by new solder, |
| Test Methods and | Solder temperature : 245±3°C (Sn/3,0Ag/0,5Cu) |
| Remarks | Duration ; 4±1 sec. |
| vernet AS | Expression: , Table 5805 |

| Resistance to S | | | | |
|---|--|---|---|---------------------------|
| Specified Value | Appearance: No significant abnormality Inductance change: Within ±1096 | | | |
| Test Methods and Remarks | Solder temperature Duretion Preheating tempera Preheating time Flux Recovery | : 10±0,5 sec. sture : 150 to 180°C : 3 min. : Immersion into ethanol | solution with colophony for 3 to 5 sec nder the standard condition after the | |
| 12. Thermal Shock | | | | |
| Specified Value | Appearance: No sig Inductance change | nificant abnormality Within ±10% | | |
| Test Methods | Conditions for 1 cy | | | |
| | Step | temperature (°C) | time (min.) | |
| | 1 | -40 +0/-3 | 30±3 | |
| | 2 | Room temperature | 2~3 | |
| and Remarks | 3 | +85 +3/-0 | 30±3 | |
| | 4 Number of cycles: | Room temperature | 2~3 | |
| | | | | |
| 13. Damp Heat (St Specified Value | | | | |
| | Appearance: No sig Inductance change Temperature : Humidity : Duration : | Within ±10% 60±2°C 90 to 95%RH 500+24/−0 hrs | dard condition after the removal from | test chamber (See Note 1) |
| Specified Value | Appearance: No sig Inductance change Temperature : Humidity : Duration : | Within ±10% 60±2°C 90 to 95%RH 500+24/−0 hrs | dard condition after the removal from | test chamber,(See Note I) |
| Specified Value Test Methods and Remarks | Appearance: No sig Inductance change Temperature : Humidity : Duration : Recovery : | Within ±10% 60±2°C 90 to 95%RH 500+24/~0 hrs 2 to 3 hrs of recovery under the star | dard condition after the removal from | test chamber (See Note 1) |
| Specified Value | Appearance: No signductance change Temperature: Humidity: Duration: Recovery: Damp Heat Appearance: No signductance change | Within ±1096 60±2°C 90 to 9595RH 500 +24'-0 hrs 2 to 3 hrs of recovery under the star | dard condition after the removal from | test chamber.(See Note 1) |
| Specified Value Test Methods and Remarks 14. Loading under D | Appearance: No sig Inductance change Temperature: Humidity: Duration: Recovery: | . Within ±10% 50±2°C 90 to 95%PH 500 ±24°C hrs 2 to 3 hrs of recovery under the star | dard condition after the removal from | |
| Specified Value Test Methods and Remarks 14. Loading under D Specified Value Test Methods and Remarks | Appearance: No significance change: Inductance change: Humidity: Duration: Recovery: Camp Heat Appearance: No significance change Temperature Humidity Applied current Duration Recovery | . Within ±10% 50±2°C 90 to 95%PH 500 ±24°C hrs 2 to 3 hrs of recovery under the star | | |
| Specified Value Test Methods and Remarks 14. Loading under D Specified Value Test Methods and Remarks | Appearance: No signature in Inductance change Temperature : Humidity : Duration : Recovery : Damp Heat Appearance: No signature change Temperature Humidity Applied current Duration Recovery Temperature | . Within ±10% 50±2°C 90 to 9596RH 500 +24°-0 hrs 2 to 3 hrs of recovery under the star prificant abnormality . Within ±10% . 90±2°C . 90±2°C . 106270x . 106270x . 500 +24′-0 hrs . 2 to 3 hrs of recovery under the s | | |
| Specified Value Fest Methods and Remarks 14. Loading under E Specified Value Fest Methods and Remarks 15. Loading at High | Appearance: No signification inductance change Temperature: Humidity: Duration: Recovery: Duration: Recovery: Duration: Recovery: Recovery: Duration: Recovery: Recove | . Within ±1096 50±2°C 90 to 9596RH 500 +24/~0 hrs 2 to 3 hrs of recovery under the star inficant abnormality . Within ±1096 : 90 to 9596RH :1662max : 500 +24/~0 hrs : 106 +27 + 106/-106/-106/-106/-106/-106/-106/-106/- | | |
| Specified Value Test Methods and Remarks 14. Loading under E Specified Value Test Methods and | Appearance: No eight of the control | Within ±1096 50±2°C 90 to 9596RH 90 to 9596RH 2 to 3 livs of recovery under the star pulsant abnormality Within ±1096 1.80 to 9596RH 1.90 to | | |

(Note 1) Measurement shall be made after 48 ±2 hrs of recovery under the standard condition, standard condition, "referred to here in a defined as follows:

§ to 35° Of empressure, \$5 to 85% relative humidary.

When there are questions concerning measurement results:

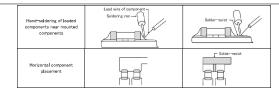
In order to provide correlation data, the tests after be conducted under condition of 20 ±2°C of temperature, 80 to 70% relative humiday, and 86 to 106/Pa of air pressure. Unless otherwise specified, all the tests are conducted under order or "standard condition."

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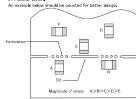
Multilayer Metal Power Inductors MCOIL™ LSCN series for General Electronic Equipment for Consumer
Multilayer Metal Power Inductors MCOIL™ LLCN series for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

■PRECAUTIONS ◆ Verification of operating environment, electrical rating and performance 1. A malfunction in medical equipment, spacecraft, muclear resectors, etc. may cause serious harm to human life or have severe social ramifications. As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications. 2. When inductors are used in places where dew condensation develops and or where corrowing as such as hydrogen sulfide, sulfurous acid, or chlorine exists in the air, characteristic deterioration may occur. Please do not use inductors under such environmental conditions. 4. Departing Current (Verification of Rated current) 1. The operating current inclusing invalue current in rinductors must always be lower than their rated values. 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect. 4. Temporature in a crosses of the rated value because the inductance may be reduced due to the magnetic saturation effect. 4. Temporature rise of power choke cold depends on the installation condition in end products. Make sure that temperature rise of power choke cold in actual end products is within the specified temperature range. Make sure that temperature rise of power choke coils in actual end products is within the specified temperature range. 2. PCB Design Plattern configurations (Dasign of Land-natterns) When inductors are mounted on a DOB, the size of land patterns and the amount of solder used size of filled) can directly affect inductor performance. Intervation, the following items must be carefully considered in the design of solder land patterns: (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing lamp-statems is to research to consider the appropriate size and configuration of the solder patk which in turn determines the amount of solder necessary to form the filless. (2) When more than one part is giority soldered notice the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist. *Pattern configurations (inductor bysource to manifested Everakoway) PC boards. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (CFG durings bear induction mounts) or distinguished and the chasts, were collecting the reflex soldered by the chasts. stress. **Pottern configurations(Design of Land-patterns) The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts, Examples of improper pattern designs are also shown. (1) Recommended fand dimensions for a typical chip inductor land patterns for PCBs A B A (2) Examples of good and bad solder application Chassis Solder (for groundin





2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.
An example below should be counted for better design.

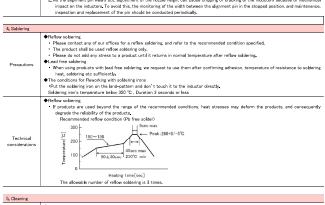


When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are lated in order from least stressful to most stressful such-back, allt. V-growing and perforation. Thus, any ideal DMI inductor layout must also consider the PGO splitting procedure.

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| Precautions | 1. Exc | | be imposed on the inductors when mounting o of the mounter should be conducted periodicall | |
|-----------------------------|-----------------------|--|--|--|
| | 1. If to fo (1) | llowing points should be consider. The lower limit of the pick-up board. The pick-up pressure should. To reduce the amount of delivers. | lered before lowering the pick-up nozzle: p nozzle should be adjusted to the surface leve be adjusted between 1 and 3N static loads. | on the inductors, causing damage. To avoid this, and of the PC board after correcting for deflection of the PC board after correcting for deflection of the PC board after correcting for deflection of the PC board after correcting the PC board after the PC boar |
| | | Item | Improper method | Proper method |
| Technical considerations | | Single-sided mounting | chipping or cracking | supporting pins — |
| | | Double-sided mounting | chipping of cracking | supporting pins or backrup pins |



Presentions

Cleaning conditions

Washing by supersonic waves shall be avoided.

Technical
considerations

If washed by supersonic waves, the products might be broken.

| Precautions | With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance. 2. Thermal expansion and thermal phir/kage characteristics of resina may lead to the deterioration of inductors' performance. |
|------------------------|---|
| | When a resin hardening temperature is higher than inductor operating temperature, the stresses generated by the excessive heat may lead to damage in inductors. |
| | 4. In prior to use, please make the reliability evaluation with the product mounted in your application set. |
| | |
| . Handling | |
| | ◆Breakaway PC boards(splitting along perforations) |
| | When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection |
| | or twisting to the board. |
| | Board separation should not be done manually, but by using the appropriate devices. |
| | General handling precautions Always wear static control bands to protect against ESD. |
| | Always wear static control bands to protect against ESU. Keep the inductors away from all magnets and magnetic objects. |
| | Neep the inductors away from all magnets and magnetic objects. Use non-magnetic tweezers when handling inductors. |
| Precautions | Any devices used with the inductors(soldering irons, measuring instruments) should be properly grounded. |
| | Keep bare hands and metal products (i.e. metal desk) away from inductor electrodes or conductive areas that lead to chip electrodes, |
| | Keep inductors away from items that generate magnetic fields such as speakers or coils. |
| | Mechanical considerations |
| | Be careful not to subject the inductors to excessive mechanical shocks. |
| | (1) If inductors are dropped on the floor or a hard surface they should not be used. |
| | (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or burns against other |
| | boards or components. |
| | |
| Storage cond | itions |
| | ♦ Storage |
| | To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control |
| | |
| | temperature and humidity in the storage area. Humidity should especially be kept as low as possible. |
| Donorotiono | temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions |
| Precautions | |
| Precautions | Recommended conditions |
| Precautions | - Recommended conditions Arabient temperature: 30°C or below Humidity; 30°t to 70°s. The arabient temperature must be kept +5°C to +40°C, Even under ideal extrage conditions, solderability of inductor is deteriorated as time passes, on inductor selvable bused within fromther from the time of delivery. |
| Precautions | Recommended conditions Arabient temperature: 30°C or below Humidity; 30°s to 70% The arabient temperature must be kept =5°C to +40°C. Even under ideal storage conditions, solderability of inductor is deteriorated as |
| | Raboenmended conditions Another temperature: 30°C or below Humidity: 30°, to 70% The arbient temperature must be kept +5°C to +40°C. Even under ideal atorage conditions, solderability of inductor is deteriorated as time passes, to inductor should be used within farother from the time of delivery. **Conductor should be kept where no chlorine or sulfur exists in the air. **Storage** **Storage** **Storage** **Storage** **Total Conductor should be kept where no chlorine or sulfur exists in the air. |
| Precautions Technical | Recommended conditions Arabient temperature: 30°C or below Humidity: 30° to 70°6. The arabient temperature must be kept "5°C to +40°C, Even under ideal storage conditions, solderability of industor is deteriorated as time passes, so industors should be used within 6 months from the time of delivery. Industors should be kept where no obforme or safer usefs in the air. |

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For steads of each product (characteristics graph, refluidity information, precautions for use, and so only, see our Wide site Patty / (www.gs-squ.com/).

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